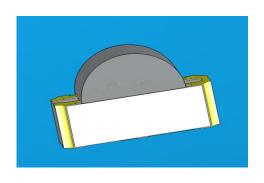


DATASHEET

SMD B

12-22AUYSYGC/S530-A2/TR8



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- · Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

• The 12-22A SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.



• Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- · General use.

Device Selection Guide

Chip Type	Chip Materials	Emitted Color	Resin Color		
UY	AlGalnP	Brilliant Yellow	— Water Clear		
SYG	AlGalnP	Brilliant Yellow Green	water Clear		

Absolute Maximum Ratings (Ta=25)

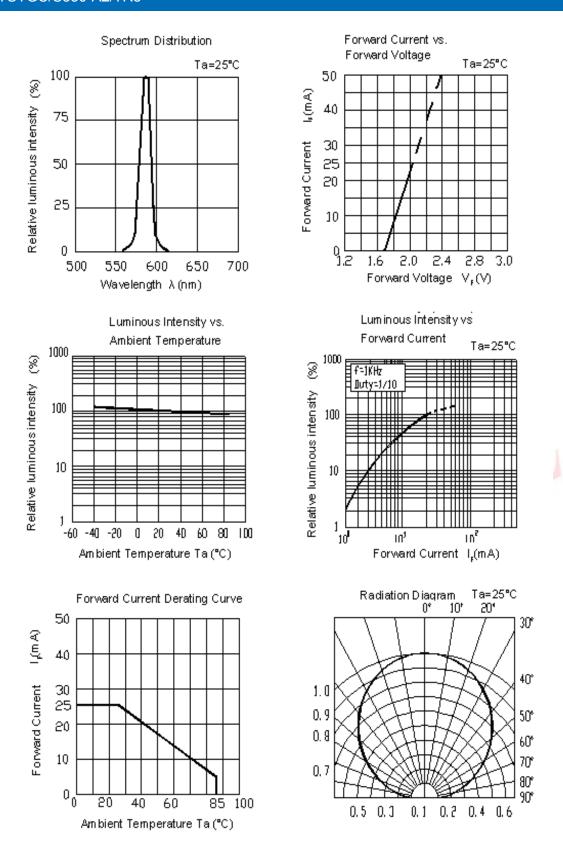
Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I _F	25	mA
Peak Forward Current	1	UY:60	mA
(Duty 1/10 @1KHz)	I _{FP}	SYG:60	IIIA
Power Dissipation	Pd	60	mW
Operating Temperature	T_{opr}	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Electrostatic Discharge	ESD _{HBM}	2000	V
Soldering Temperature	T_{sol}	Reflow Solderi	ng: 260 for 10 sec.
		Hand Soldering	g: 350 for 3 sec.



Electro-Optical Characteristics (Ta=25)

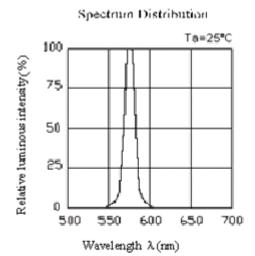
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	UY: 18.0	38.0		mcd	
Luminous intensity	IV	SYG: 13.0	19.0			
Viewing Angle	$2\theta_{1/2}$		120		deg	
Peak Wavelength	n	UY :	591		nm	— I _F =20mA —
reak vvaveletigiti	р	SYG :	575			
Dominant Wayalanath	d	UY :	589		nm	
Dominant Wavelength	u	SYG :	573			
Spectrum Rediction Randwidth		UY :	15		nm	
Spectrum Radiation Bandwidth		SYG :	20			
Converd Voltogo	V	UY :	2.0	2.4	V	
Forward Voltage	V_{F}	SYG :	2.0	2.4		
Deverse Current	1	UY :		10	μΑ	V _R =5V
Reverse Current	I _R	SYG :		10		

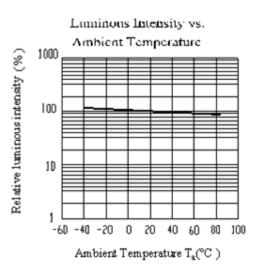
Typical Electro-Optical Characteristics Curves
UY

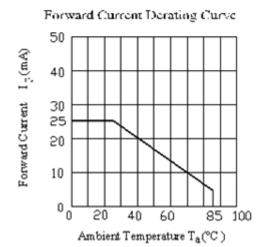


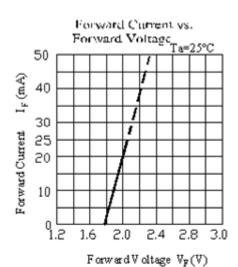
Typical Electro-Optical Characteristics Curves SYG

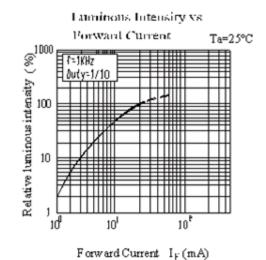
Expired Period: Forever

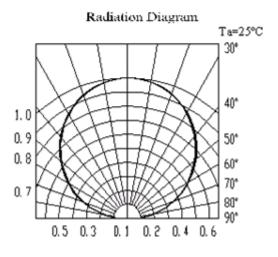






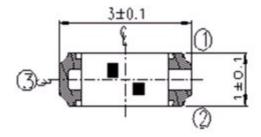




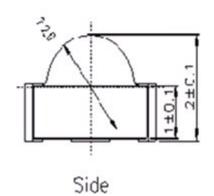


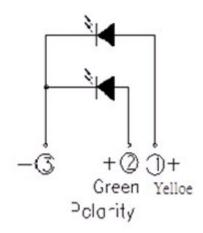
Expired Period: Forever

Package Outline Dimensions

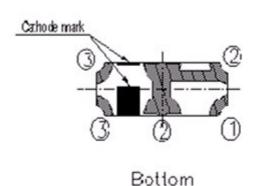


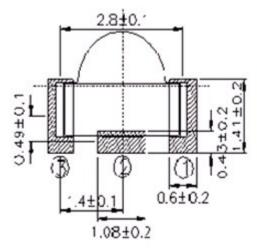
Тор





Recommenc Sodering Pad





Expired Period: Forever

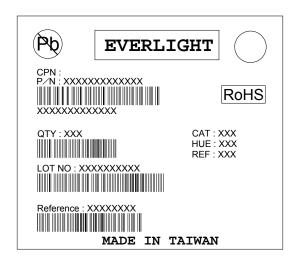
regested pad dimension is just for reference only.

ease modify the pcd dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

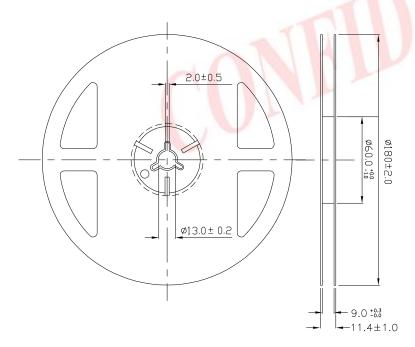


Moisture Resistant Packing Materials Label Explanation



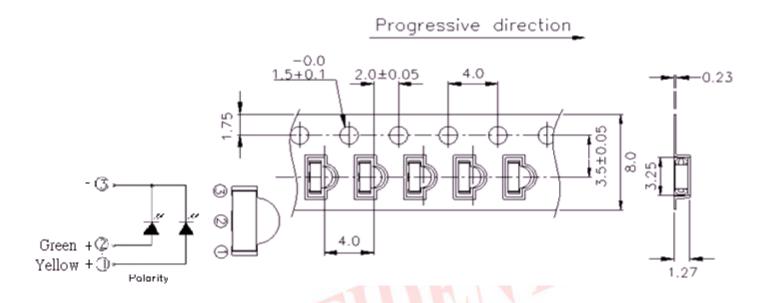
- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions



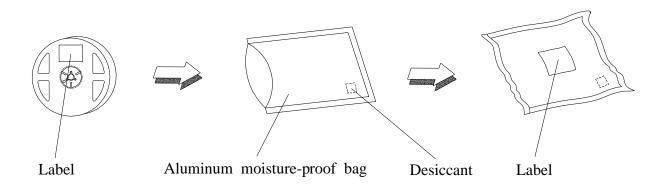
Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Expired Period: Forever

Precautions For Use

1. Over-current-proof

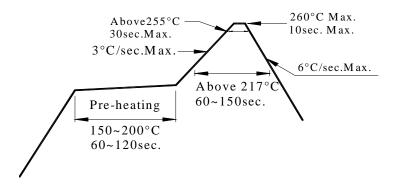
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 After opening the package: The LEDs should be kept at 30 or less and 60%RH or less.
- 2.3 The LEDs should be used within 168 hours (7days) after opening the package.

 If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5 for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.



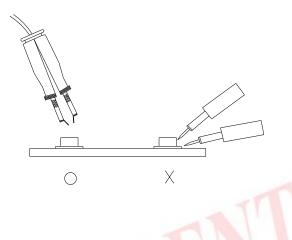
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.